CLASSIFICATION PF	RODUCT SPECIFICATI	ON	No. DS-172x-2400-1	02	REV. 1.3
	UETOOTH LOW ENEF	RGY	PAGE	1 of 2	29
CUSTOMER'S CODE PAN172x / PAN1721	PANASONIC'S CODE ENW89820AxKF / ENW8		DATE	16.08.20)12
Specif	fication for	Prod	luction		
Applicant / Manufacturer Hardware	Panasonic Industria Zeppelinstrasse 19 21337 Lüneburg Germany	I Devices Eu	ırope GmbH		
Applicant / Manufacturer Software	Please refer to chap Software Versions	oter 22 / 22.1	Information rega	rding	
Software Version	Please refer to chap Software Versions	oter 22 / 22.1	Information rega	rding	
By purchase of any of produ document's validity and dec recommendations. Panasor notification.	lares their agreement nic reserves the right t	and unders o make cha	standing of its co anges as require	ontents a	and ut
Power Electronics R&D Wireless Connectivi Panasonic Industrial Devices E	Center ge	PROVED enehmigt	CHECKED geprüft		GNED stellt

CLASSIF	ICATION	PRO	DUCT SPECIFICATION	No. DS-172x-24	400-102	REV. 1.3
SUBJEC ⁻			ETOOTH LOW ENERGY MODE MODULE	PAGE	2 of 2	29
	IER'S CODE (/ PAN1721		ANASONIC'S CODE NW89820AxKF / ENW89835AxKF	DATE	16.08.20	012
TAB	LE OF CONTEI	NTS				
1.	•					
2.	Difference PAN	11720 / PAN	V1721			.4
3.	Key Features					.4
4.	Bluetooth Low E	Energy				.5
5.	Applications for	the Modul	θ			.5
6.	Description for t	the Module				.5
7.	Detailed Descri	ption				.6
	7.1. PAN172x	Terminal L	ayout			.6
8.	Bluetooth Featu	ures				.8
9.	Block Diagram.					.8
10.	Test Conditions	s				.9
11.	General Device	Requirem	ents and Operation			.9
	11.1. Absolute I	Maximum I	Ratings			.9
	11.2. Recomme	ended Ope	rating Conditions			.9
	11.3. Current C	consumptio	n		····· · · · · · · · · · · · · · · · ·	10
12.	Bluetooth RF Pe	erformance)		····· · · · · · · · · · · · · · · · ·	11
	12.1. Bluetooth	Characteri	stics		····· · · · · · · · · · · · · · · · ·	11
13.	Soldering Temp	perature-Tir	me Profile (for reflow soldering)		····· · · · · · · · · · · · · · · · ·	12
	13.1. For lead s	solder			····· · · · · · · · · · · · · · · · ·	12
	13.2. For leadfr	ree solder			····· · · · · · · · · · · · · · · · ·	12
14.	Module Dimens	sion			····· · · · · · · · · · · · · · · · ·	13
15.	PAN172x FootF	Print of the	Module		····· · · · · · · · · · · · · · · · ·	14
16.	Case Marking				····· · · · · · · · · · · · · · · · ·	15
	16.1. Example f	for Marking			····· · · · · · · · · · · · · · · · ·	15
	16.2. Marking D	Definition			······	15
17.	Mechanical Rec	quirements			····· · · · · · · · · · · · · · · · ·	15
18.	Development of	f Applicatio	ns		····· · · · · · · · · · · · · · · · ·	16
19.	Reliability Tests	3			····· ′	16
20.	Cautions				····· ′	16
	20.1. Design No	otes			····· ′	16
	20.2. Installation	n Notes			····· ′	17
	20.3. Usage Co	onditions N	otes		····· ´	17
	-					
	=					
	20.6. Other cau	utions			······	18
21.	Packaging					20
	21.2. Packing ir	n Tape				20
	21.3. Compone	ent Direction	۱			21

CLASSIF		RODUCT SPECIFICATION	No. DS-172x-2400-102	REV. 1.3
SUBJECT	I SING	UETOOTH LOW ENERGY	PAGE 3 (of 29
	IER'S CODE / PAN1721	PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE 16.0	8.2012
	21.4. Reel Dimension			21
	21.5. Label for Package			22
22.	-			
		ling Software Versions		
23.	RoHS and REACH Dec	aration		24
24.	Data Sheet Status			25
25.	History for this Documer	nt		25
26.	Related Documents			25
27.	General Information			26
28.	Regulatory Information.			26
	28.1. FCC Notice			26
	28.2. Caution			26
	28.3. Labeling Requiren	nents		27
	28.4. Antenna Warning			27
	28.5. Approved Antenna	a List		27
	28.6. RF Exposure PAN	I172x		27
29.	Industry Canada Certific	ation		28
	29.1. IC Notice			28
	29.2. Labeling Requiren	nents		28
30.	European R&TTE Decla	ration of Conformity		28
31.	Life Support Policy			29

CLASSIFICATION PI	RODUCT SPECIFICATION	No. DS-172x-2400-102	REV. 1.3
	LUETOOTH LOW ENERGY GLE MODE MODULE	PAGE 4	of 29
CUSTOMER'S CODE PAN172x / PAN1721	PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE 16.	08.2012
1. SCOPE OF THIS DOCUMEN	Т		
series number: PAN1720 (CC25	s to Panasonic's, Class 2, Bluetooth® ¹ lo 40 from Texas Instruments) and PAN17 versions of the PAN172x are available.		
2. DIFFERENCE PAN1720 / PA	N1721		
Difference PAN1720 and PAN17 Both are refered to PAN172x in t	21 is the IC from Texas Instruments onl his document.	у.	
on the CC2540 and the I2C/extra provides lower RF current consu	ith the CC2540 in the 6-mm × 6-mm QF a I/O is not used on the CC2541. Compa mption. The CC2541 does not have the power in TX mode. The CC2541 also ac	red to the CC2540, the USB interface of the C	CC2541
More detailed differences regard datasheets from Texas Instrume	ing the IC, which have an impact on the nts.	module can be seen in	the
CC2540 from Texas Instruments	-		
CC2541 from Texas Instruments	1		
3. KEY FEATURES			
 High sensitivity (-94 dE Texas Instrument's CC High performance low No external componen Fast Connection Setup Internal crystal oscillate Internal 32khz crystal oscillate Two powerful USARTs USB direct support Powerful five channel I 	5.6 x 8.7 x 1.8 mm ³ er (typical) with transmit power cont 3m typ.) 52540 Single Chip BLE Solution insi- power 8051 Microcontroller core ts needed or (26MHz) oscillator for Sleep Timer 5 DMA d e.g. Battery Monitor and Temperat resist EMI	de	
¹ Bluetooth is a registered tradem	ark of the Bluetooth Special Interest Gro	oup.	

CLASSIFICATION	PRODUCT SPECIFICATION	No. DS-172x-2	2400-102	REV. 1.3	
SUBJECTCLASS 2 BLUETOOTH LOW ENERGY SINGLE MODE MODULEPAGE5 of 29					
CUSTOMER'S CODE PAN172x / PAN1721	PANASONIC'S CODE ENW89820AxKF / ENW89835A	AxKF DATE	16.08.20	012	
Bluetooth Low Energy	(BLE) part of Bluetooth Ver 4.0 specifies	two types of implem	entation. Single	mode	
and dual mode. Single power of classic Blueto applications for the firs are likely to become a Single mode Bluetooth	(BLE), part of Bluetooth Ver. 4.0, specifies e mode chips implement the low energy spe ooth, allowing the short-range wireless stan st time. Dual mode chips combine low energy de facto feature in almost all new Bluetooth n 4.0 Low Energy is not backwards compatil bw Energy is backwards compatible but is n roducts	cification and consu dard to extend to co by with the power of a enabled cellular ph ble with previous Blu	me just a fractic in cell battery classic Bluetood iones and comp uetooth standard	on of the th and outers. ds. Dual	

5. APPLICATIONS FOR THE MODULE

All Embedded Wireless Applications

- Access Points
- Industrial Control
- Medical
- Scanners
- Wireless Sensors
- Low Power

- Proximity
- Smart Phone
- Access Points
- Temperature
- Wellness
- Sports

6. DESCRIPTION FOR THE MODULE

The PAN172x is a short-range Class 2 BLE single mode module for implementing Bluetooth functionality into various electronic devices. A block diagram can be found in chapter 9.

The PAN172x is a cost-effective, low-power, true system-on-chip (SoC) for Bluetooth low energy applications. It enables robust BLE master or slave nodes to be built with very low total bill-of-material costs. The PAN172x combines an excellent RF transceiver with an industry-standard enhanced 8051 MCU, in-system programmable flash memory, 8-KB RAM, and many other powerful supporting features and peripherals. The PAN172x is suitable for systems where very low power consumption is required. Very low-power sleep modes are available. Short transition times between operating modes further enable low power consumption.

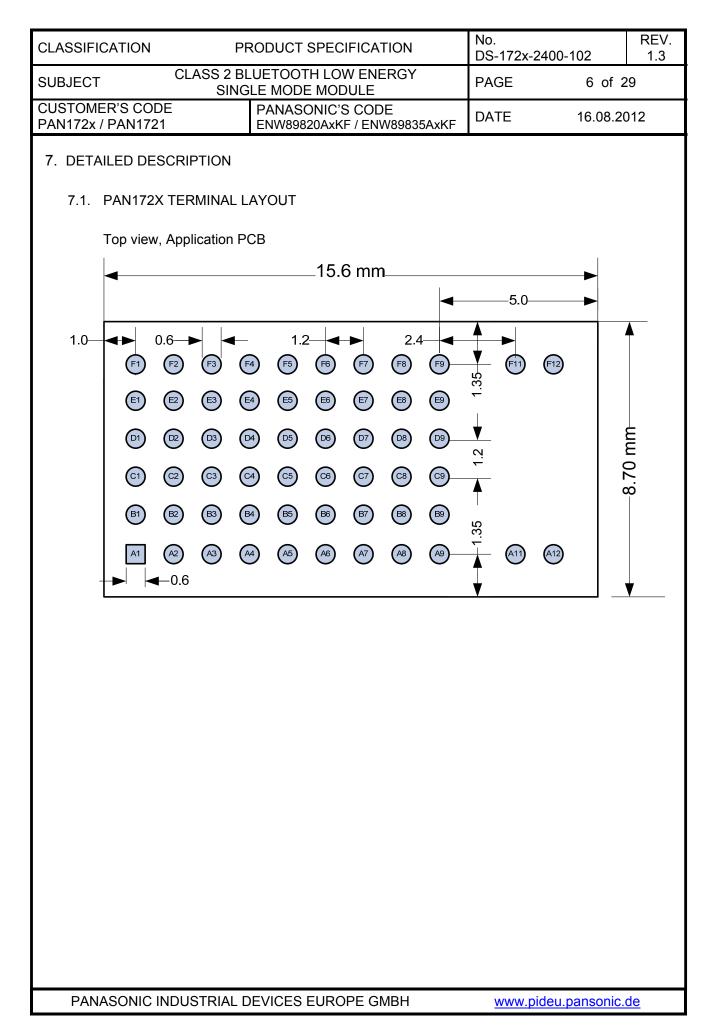
Combined with the Bluetooth low energy protocol stack from Texas Instruments, the PAN172x forms the market's most flexible and cost-effective single-mode Bluetooth low energy solution.

Additional embedded software solutions and profiles are available from other Panasonic software partners. Refer to [1] PAN172xETU Design-Guide and chapter 22 Ordering Information.

Please contact your local sales office for further details on additional options and services:

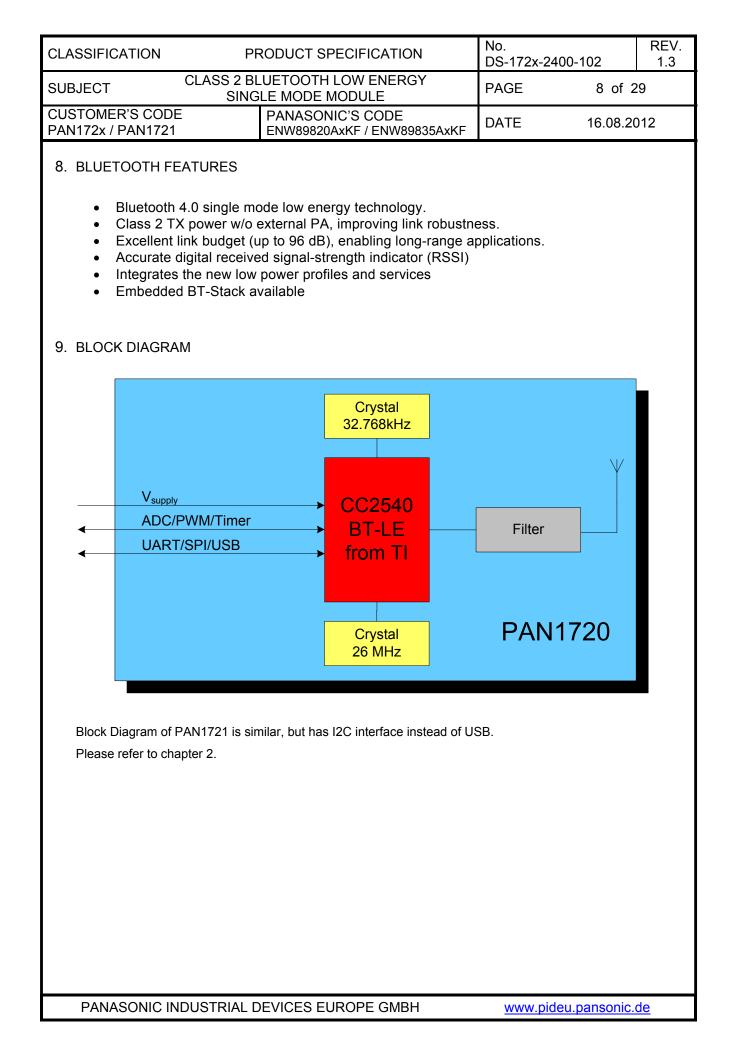
<u>www.panasonic.com/rfmodules</u> for the US, <u>http://industrial.panasonic.com/eu/i/29606/wireless_modules/wireless_modules.html</u> for EU

or write an e-mail to wireless@eu.panasonic.com.



CLASSIFICA	TION		PRODUCT SPI		No. DS-172x-2400-1	02 RE\ 1.3
SUBJECT			BLUETOOTH L IGLE MODE M	LOW ENERGY ODULE	PAGE	7 of 29
CUSTOMER PAN172x / P			PANASONI ENW89820A	C'S CODE xKF / ENW89835AxKF	DATE	16.08.2012
	No	Pin Name	Pin Type	Description		
	A1	GND	Ground Pin	Connect to Ground		
	A1 A2	P1.0	Digital I/O	Port 1.0 – 20mA drive capabi	ility	
	A3	Reset	Digital Input	Reset, active-low	inty	
	A4	VCC	Power	2V – 3.6V analog/digital pow	er supply connection	
	A5	VCC	Power	2V – 3.6V analog/digital powe		
	A6	VCC	Power	2V – 3.6V analog/digital power	er supply connection	
	A7	GND NC	Ground Pin	Connect to Ground		
	A8 A9	GND	Ground Pin	Not Connected Connect to Ground		
	A9	GND	Ground Pin	Connect to Ground		
	A12	GND	Ground Pin	Connect to Ground		
	B1	P1.3	Digital I/O	Port 1.3		
	B2	P1.2	Digital I/O	Port 1.2	114 .	
	B3 B4	P1.1 P0.6	Digital I/O Digital I/O	Port 1.1 – 20mA drive capabi Port 0.6	llity	—
	B4 B5	NC		Not Connected		—
	B6	P0.1	Digital I/O	Port 0.1		
	B7	P0.0	Digital I/O	Port 0.0		
	B8	NC		Not Connected		
	B9	NC		Not Connected		
	C1 C2	NC P1.4	Digital I/O	Not Connected Port 1.4 / BR-SW UART CTS	1	—
	C2	P1.4 P1.5	Digital I/O	Port 1.4 / BR-SW UART CTS		—
	C4	P0.7	Digital I/O	Port 0.7	·	
	C5	NC		Not Connected		
	C6	NC		Not Connected		
	C7	NC	Cround Din	Not Connected		
	C8 C9	GND GND	Ground Pin Ground Pin	Connect to Ground Connect to Ground		
	D1	DVDD USB	Power (digital)	2V – 3.6V digital power supp	ly connection	
	D2	USB_N	Digital I/O	USB N / PAN1721 I2C SDA /	// Leave floating if not use	
	D3	USB_P	Digital I/O	USB P / PAN1721 I2C SCL /	/ Leave floating if not use	ed.
	D4	NC		Not Connected		
	D5 D6	NC NC		Not Connected Not Connected		
	D0	GND	Ground Pin	Connect to Ground		
	D8	GND	Ground Pin	Connect to Ground		
	D9	NC		Not Connected		
	E1	P2.1/DD	Digital I/O	Port 2.1 / Programming Inter		—
	E2 E3	P2.2/DC DGND USB	Digital I/O Ground Pin	Port 2.2 / Programming Interf Connect to Ground		
	E4	NC		Not Connected		
	E5	NC		Not Connected		
	E6	P0.2/RX/MISO	Digital I/O	Port 0.2 / TI-SW UART RX /	SPI MISO	
	E7	NC	Cround Dir	Not Connected		
	E8 E9	GND GND	Ground Pin Ground Pin	Connect to Ground Connect to Ground		—
	F1	GND	Ground Pin	Connect to Ground		
	F2	P1.6	Digital I/O	Port 1.6 / BR-SW UART TX		
	F3	P1.7	Digital I/O	Port 1.7 / BR-SW UART RX		
	F4	P2.0	Digital I/O	Port 2.0		
	F5 F6	P0.4/CTS/CS NC	Digital I/O	Port 0.4 / TI-SW UART CTS / Not Connected	1 521 65	—
	F6	P0.3/TX/MOSI	Digital I/O	Port 0.3 / TI-SW UART TX /S	PI MOSI	—
	F8	P0.5/RTS/CLK	Digital I/O	Port 0.5 / TI-SW UART RTS		
	F9	GND	Ground Pin	Connect to Ground		
	F11	GND	Ground Pin	Connect to Ground		
	F12	GND	Ground Pin	Connect to Ground		

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CLASSIFI	CAT	ION	PRODUCT	SPECIFICATIO	N	No. DS-172x-2400-1	102	REV 1.3
SUBJECT		CLA	SS 2 BLUETOO SINGLE MOD		GY	PAGE	9 of 2	29
CUSTOMI PAN172x				ONIC'S CODE 20AxKF / ENW8	9835AxKF	DATE	16.08.20	012
10.TEST	ГСО	NDITIONS						
Measu	urem	ents shall be r	nade under operat	ing free-air temp	erature range	e unless otherwise	specified.	
Tempo Humic Supply	dity		25 ± 10°C 40 to 85%RH 3.3V					
11.GENI	ERA	L DEVICE R	EQUIREMENTS	AND OPERAT	ION			
All spe	ecific	ations are ove	r temperature and	process, unless	indicated oth	erwise.		
	ABS	SOLUTE MA	r temperature and	•	indicated oth	erwise.		
	ABS			•	indicated oth	value	Unit	
·	ABS No	SOLUTE MA		S	indicated oth			
·	ABS No Ratir	SOLUTE MA	XIMUM RATING	S e Range		Value -0.3 to 3.9	Unit V	
·	ABS No Ratir	SOLUTE MA	XIMUM RATING	S e Range		Value	V	
·	ABS No Ratir	SOLUTE MA See ² ngs Over Operatin Supply voltage Voltage on any d	XIMUM RATING	S e Range		Value -0.3 to 3.9 -0.3 to	V	
·	ABS No Ratir 1 2 3	SOLUTE MA See ² ngs Over Operatin Supply voltage Voltage on any d	XIMUM RATING g Free-Air Temperature All supply pins must ha igital pin nt temperature range	S e Range		Value -0.3 to 3.9 -0.3 to VDD+0.3 <3,9	V 0. V	
	ABS No Ratir 1 2 3 4	SOLUTE MA See ² ngs Over Operatin Supply voltage Voltage on any d Operating ambie	XIMUM RATING g Free-Air Temperature All supply pins must ha igital pin nt temperature range ture range	S e Range		Value -0.3 to 3.9 -0.3 to VDD+0.3 <3,9 -40 to 85	V V V °C	
	ABS No Ratir 1 2 3 4 5	SOLUTE MAX See ² ngs Over Operatin Supply voltage Voltage on any d Operating ambie Storage tempera Bluetooth RF inp ESD: All pads, accordii	XIMUM RATING g Free-Air Temperature All supply pins must ha igital pin nt temperature range ture range	S e Range ave the same voltage el, JEDEC STD 22, n	nethod A114	Value -0.3 to 3.9 -0.3 to VDD+0.3 <3,5	V V V °C °C	
11.1.	ABS No Ratir 1 2 3 4 5 6	SOLUTE MAX See ² ngs Over Operatin Supply voltage Voltage on any d Operating ambies Storage tempera Bluetooth RF inp ESD: All pads, accordin According to cha	XIMUM RATING Ig Free-Air Temperature All supply pins must ha igital pin Int temperature range ture range uts Ing to human-body mod	e Range ave the same voltage el, JEDEC STD 22, method	nethod A114	Value -0.3 to 3.9 -0.3 to VDD+0.3 <3,5	V V °C °C dBm	
11.1.	ABS No Ratir 1 2 3 4 5 6	SOLUTE MAX See ² ngs Over Operatin Supply voltage Voltage on any d Operating ambies Storage tempera Bluetooth RF inp ESD: All pads, accordin According to cha	XIMUM RATING Ig Free-Air Temperature All supply pins must ha igital pin Int temperature range ture range uts Ing to human-body mod rged-device model, JEI	e Range ave the same voltage el, JEDEC STD 22, method	nethod A114	Value -0.3 to 3.9 -0.3 to VDD+0.3 <3,5	V V °C °C dBm	
11.1.	ABS No Ratir 1 2 3 4 5 6 8	SOLUTE MAX See ² ngs Over Operatin Supply voltage Voltage on any d Operating ambies Storage tempera Bluetooth RF inp ESD: All pads, accordin According to cha	XIMUM RATING Ig Free-Air Temperature All supply pins must ha igital pin It temperature range ture range uts Ing to human-body mod rged-device model, JEI DOPERATING	e Range ave the same voltage el, JEDEC STD 22, n DEC STD 22, method CONDITIONS	nethod A114 C101	Value -0.3 to 3.9 -0.3 to VDD+0.3 <3,9	V V °C °C dBm	

² Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

PANASONIC INDUSTRIAL DEVICES EUROPE GMBH

	INGLE M	OOTH LOW ENERGY	DS-172x-2			
ER'S CODE		10DE MODULE	PAGE	10) of 2	1. 9
		NASONIC'S CODE W89820AxKF / ENW89835AxKF	DATE	16.	.08.20	12
CURRENT CONSUL	MPTION					
	ne total p	ependant on the user scenario a ower consumption can be optim				
Characteristics" in Te	exas Inst	ruments datasheet, refer to [2].				
	ents CC254		VDD = 3 V			
PARAMETER		Power mode 1. Digital regulator on; 16-MHz RC 32-MHz crystal oscillator off; 32.768-kHz XOSC	C, POR, BOD			UNIT
Icore Core current consump	tion	Power mode 2. Digital regulator off; 16-MHz RC 32-MHz crystal oscillator off; 32.768-kHz XOSC	COSC and	0	.9	μA
		Power mode 3. Digital regulator off; no clocks; RAM and register retention	-	0	.4	
		peripherals. No flash access, no RAM access.	radio or			mA
						μΑ
Peripheral current con		Timer 2. Timer running, 32-MHZ XOSC used		5	90	μΑ
	sumption	Timer 3 Timer running 32 MHz XOSC used		6	20	ΠA
Iperi (Adds to core current I	_{core} for each	Timer 3. Timer running, 32-MHz XOSC used			30 70	μA uA
Iperi (Adds to core current I peripheral unit activate	_{core} for each	Timer 3. Timer running, 32-MHz XOSC used Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC		7	30 70 .6	μΑ μΑ μΑ
Iperi (Adds to core current I	_{core} for each	Timer 4. Timer running, 32-MHz XOSC used		7 0	70	μA
Iperi (Adds to core current I	_{core} for each d)	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting		7 0	70 .6	μΑ μΑ
Iperi (Adds to core current I peripheral unit activate	core for each d) ERISTICS	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting	VDD = 3 V	7 0	70 .6	μΑ μΑ
Iperi (Adds to core current I peripheral unit activate	core for each d) ERISTICS	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting	VDD = 3 V MIN	0	.6 .2	μΑ μΑ
Iperi (Addis to core current I peripheral unit activate GENERAL CHARACTI Measured on Texas Instrume	core for each d) ERISTICS	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting 0 EM reference design with T _A = 25°C and		0	.6 .2	μA μA mA
Iperi (Addis to core current I peripheral unit activate GENERAL CHARACTI Measured on Texas Instrume PARAMETER	ERISTICS	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting 0 EM reference design with T _A = 25°C and	MIN	0	70 .6 .2 MAX U	μA μA mA
Iperi (Adds to core current I peripheral unit activate GENERAL CHARACTI Measured on Texas Instrume PARAMETER WAKE-UP AND TIMING	ERISTICS ents CC254 Digi osci	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting 0 EM reference design with T _A = 25°C and V TEST CONDITIONS tal regulator on, 16-MHz RCOSC and 32-MHz cry llator off. Start-up of 16-MHz RCOSC tal regulator off, 16-MHz RCOSC and 32-MHz cry llator off. Start-up of regulator and 16-MHz RCOS	vstal C	0 1 TYP M	70 .6 .2 MAX U	μA μA mA
Iperi (Adds to core current I peripheral unit activate GENERAL CHARACTI Measured on Texas Instrume PARAMETER WAKE-UP AND TIMING Power mode 1 → Active	ERISTICS ents CC254 Digi osci Digi osci Crys with	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting 0 EM reference design with T _A = 25°C and V TEST CONDITIONS tal regulator on, 16-MHz RCOSC and 32-MHz cry llator off. Start-up of 16-MHz RCOSC tal regulator off, 16-MHz RCOSC and 32-MHz cry llator off. Start-up of regulator and 16-MHz RCOS stal ESR = 16 Ω. Initially running on 16-MHz RCO 32-MHz XOSC OFF	vstal C	1 0 1 1 1 1 1 1 1 20 4 10	70 .6 .2 MAX U	μΑ μΑ mA mA
Iperi (Adds to core current I peripheral unit activate GENERAL CHARACTI Measured on Texas Instrume PARAMETER WAKE-UP AND TIMING Power mode 1 → Active Power mode 2 or 3 → Active Active → TX or RX	ERISTICS ents CC254 Digi osci Digi osci Crys with	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting 0 EM reference design with $T_A = 25^{\circ}$ C and Λ TEST CONDITIONS tal regulator on, 16-MHz RCOSC and 32-MHz cry tal regulator off, 16-MHz RCOSC and 32-MHz cry tal Same tage	vstal C	1 0 1 1 1 1 4 120 410 160	70 .6 .2 MAX U	μΑ μΑ mA mA
I _{peri} (Adds to core current I peripheral unit activate GENERAL CHARACTI Measured on Texas Instrume PARAMETER WAKE-UP AND TIMING Power mode 1 → Active Power mode 2 or 3 → Active	ERISTICS ents CC254 Digi osci Digi osci Crys with	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting 0 EM reference design with T _A = 25°C and V TEST CONDITIONS tal regulator on, 16-MHz RCOSC and 32-MHz cry llator off. Start-up of 16-MHz RCOSC tal regulator off, 16-MHz RCOSC and 32-MHz cry llator off. Start-up of regulator and 16-MHz RCOS stal ESR = 16 Ω. Initially running on 16-MHz RCO 32-MHz XOSC OFF	vstal C	1 0 1 1 1 1 1 1 1 20 4 10	70 .6 .2 MAX U	μΑ μΑ mA mA
Iperi (Adds to core current I peripheral unit activate GENERAL CHARACTI Measured on Texas Instrume PARAMETER WAKE-UP AND TIMING Power mode 1 → Active Power mode 2 or 3 → Active Active → TX or RX RX/TX turnaround	ERISTICS ents CC254 Digi osci Crys with With	Timer 4. Timer running, 32-MHz XOSC used Sleep timer, including 32.753-kHz RCOSC ADC, when converting 0 EM reference design with T _A = 25°C and V TEST CONDITIONS tal regulator on, 16-MHz RCOSC and 32-MHz cry llator off. Start-up of 16-MHz RCOSC tal regulator off, 16-MHz RCOSC and 32-MHz cry llator off. Start-up of regulator and 16-MHz RCOS stal ESR = 16 Ω. Initially running on 16-MHz RCO 32-MHz XOSC OFF	vstal C	700 1 TYP M 4 120 410 160 150	70 .6 .2 MAX U	μΑ μΑ mA mA
	Please refer for the la Characteristics" in Te values from CC2540 ELECTRICAL CHARA Measured on Texas Instrum PARAMETER	Please refer for the latest info Characteristics" in Texas Inst values from CC2540 datashe ELECTRICAL CHARACTERIST Measured on Texas Instruments CC254 PARAMETER	Please refer for the latest information for different power mod Characteristics" in Texas Instruments datasheet, refer to [2]. values from CC2540 datasheet. ELECTRICAL CHARACTERISTICS Measured on Texas Instruments CC2540 EM reference design with T _A = 25°C and PARAMETER PARAMETER Power mode 1. Digital regulator on; 16-MHz RG 32-MHz crystal oscillator off; 32.768-kHz XOSC and sleep timer active; RAM and register retention Power mode 2. Digital regulator off; 16-MHz RG 32-MHz crystal oscillator off; 32.768-kHz XOSC sleep timer active; RAM and register retention Power mode 3. Digital regulator off; 16-MHz RG Sleep timer active; RAM and register retention Power mode 3. Digital regulator off; 10 clocks; RAM and register retention Low MCU activity: 32-MHz XOSC running. No	Please refer for the latest information for different power modes to the ch Characteristics" in Texas Instruments datasheet, refer to [2]. As indication values from CC2540 datasheet. ELECTRICAL CHARACTERISTICS Measured on Texas Instruments CC2540 EM reference design with T _A = 25°C and VDD = 3 V PARAMETER PARAMETER Power mode 1. Digital regulator on; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, BOD and sleep timer active; RAM and register retention Power mode 2. Digital regulator off; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, and sleep timer active; RAM and register retention Power mode 3. Digital regulator off; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, and sleep timer active; RAM and register retention Power mode 3. Digital regulator off; 10 clocks; POR active; RAM and register retention Power mode 3. Digital regulator off; no clocks; POR active; RAM and register retention Low MCU activity: 32-MHz XOSC running. No radio or peripherals. No flash access, no RAM access. Timer 1. Timer running, 32-MHz XOSC used	Please refer for the latest information for different power modes to the chapter "El Characteristics" in Texas Instruments datasheet, refer to [2]. As indication below a values from CC2540 datasheet. ELECTRICAL CHARACTERISTICS Measured on Texas Instruments CC2540 EM reference design with T _A = 25°C and VDD = 3 V PARAMETER TEST CONDITIONS MIN TY Power mode 1. Digital regulator on; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, BOD 20 and sleep timer active; RAM and register retention Power mode 2. Digital regulator off; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, and 00 sleep timer active; RAM and register retention Power mode 3. Digital regulator off; 10-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, and 00 sleep timer active; RAM and register retention Power mode 3. Digital regulator off; 10 clocks; POR active; 00 Lore Core current consumption	Please refer for the latest information for different power modes to the chapter "Electric: Characteristics" in Texas Instruments datasheet, refer to [2]. As indication below are type values from CC2540 datasheet. ELECTRICAL CHARACTERISTICS Measured on Texas Instruments CC2540 EM reference design with T _A = 25°C and VDD = 3 V PARAMETER Power mode 1. Digital regulator on; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, BOD 235 and sleep timer active; RAM and register retention Power mode 2. Digital regulator off; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, and 0.9 sleep timer active; RAM and register retention 0.9 Power mode 3. Digital regulator off; 10-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, and 0.9 0.9 Icore Core current consumption Power mode 3. Digital regulator off; 10-MHz RCOSC and 32-MHz crystal oscillator off; 20.768-kHz XOSC, POR, and 0.9 0.9 Icore Core current consumption Power mode 3. Digital regulator off; no clocks; POR active; 0.4 0.4 Mam and register retention Power mode 3. Digital regulator off; no clocks; POR active; 0.4 0.4 Low MCU activity: 32-MHz XOSC running. No radio or peripherals. No flash access, no RAM access. 0.7 0.7

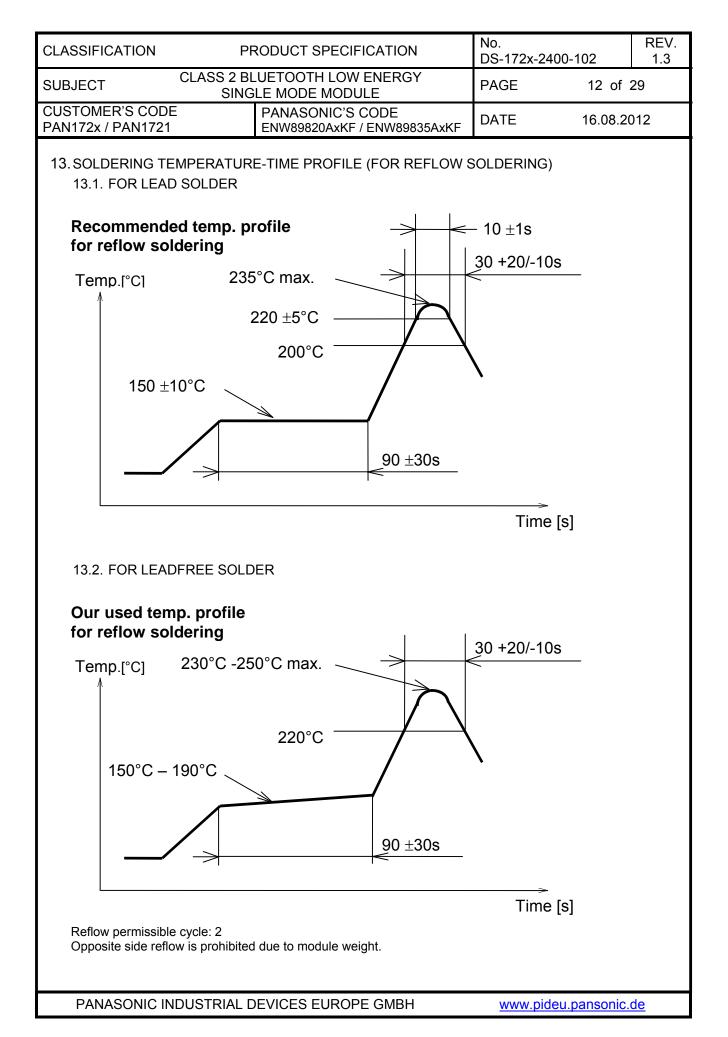
CLASSIFICATION	PF	RODUCT SPECIFICATION	No. DS-172x-240	0-102	REV. 1.3
SUBJECT		LUETOOTH LOW ENERGY SLE MODE MODULE	PAGE	11 of 2	29
CUSTOMER'S COD PAN172x / PAN1721		PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	16.08.20)12

12. BLUETOOTH RF PERFORMANCE

12.1. BLUETOOTH CHARACTERISTICS

No	Characteristics	Condition	Min	Тур	Max	BT Spec	Unit
1	Operation frequency range		2402		2480		MHz
2	Channel spacing			2			MHz
3	Output Dower	Maximum setting, measured at single ended 50ohm.		4			dBm
3	Output Power	Minimum setting, measured at single ended 50ohm.		-24			dBm
4	Constitute Llink Coin Mode	High-gain mode		-93.0		-70	dBm
4	Sensitivity, High Gain Mode	Standard mode		-92.5		-70	ubm

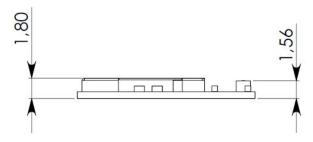
No	Characteristics	Condition	Тур	Max	Unit
1	Spurious emissions	Conducted measurement with a 50- Ω single-ended load. Complies with EN 300 328, EN 300 440 class 2, FCC CFR47, Part 15 and ARIB STD-T-66		-41	dBm

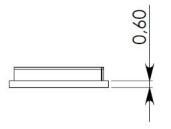


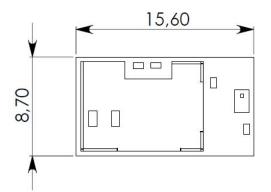
CLASSIFICATION	PR	RODUCT SPECIFICATION	No. DS-172x-24	00-102	REV. 1.3
SUBJECT		UETOOTH LOW ENERGY LE MODE MODULE	PAGE	13 of 2	29
CUSTOMER'S COD PAN172x / PAN1721		PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	16.08.20)12

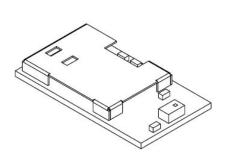
14. MODULE DIMENSION

No.	Item	Dimension	Tolerance	Remark
1	Width	8.70	± 0.20	
2	Length	15.60	± 0.20	
3	Height	1.80	± 0.20	With case

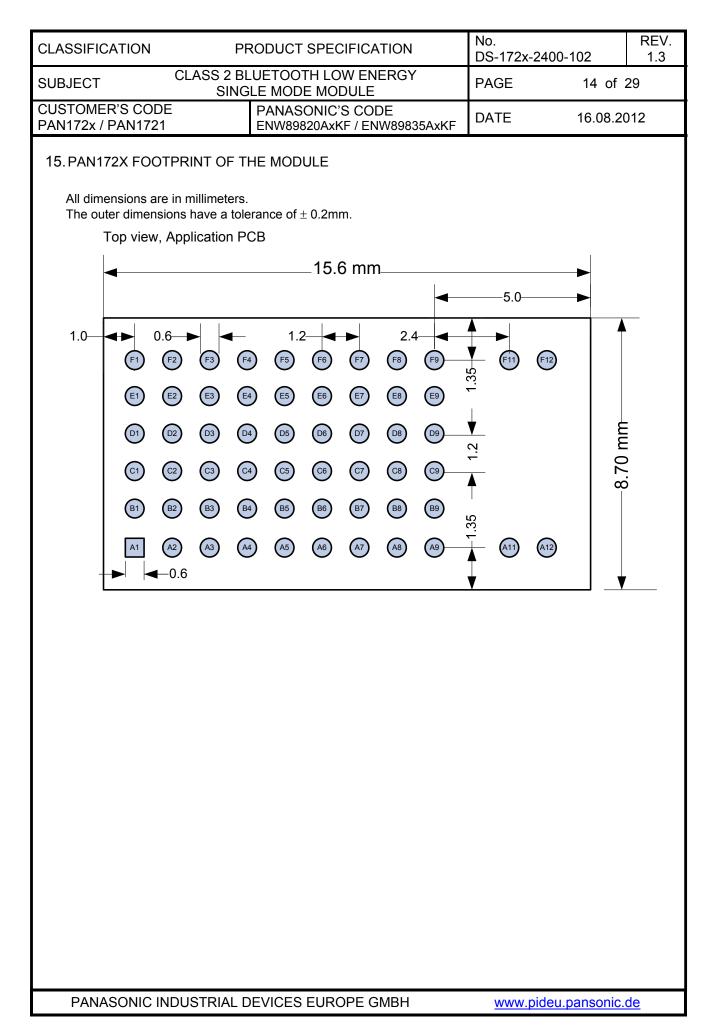






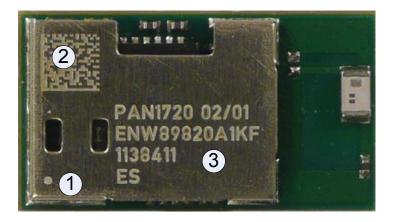


PANASONIC INDUSTRIAL DEVICES EUROPE GMBH



CLASSIFICATION	PRODUCT SPECIFICATION	No. DS-172x-240	0-102	REV. 1.3
SUBJECT	CLASS 2 BLUETOOTH LOW ENERGY SINGLE MODE MODULE	PAGE	15 of 2	29
CUSTOMER'S COD PAN172x / PAN1721		KF DATE	16.08.20)12

16. CASE MARKING



No.	Remark	
1	Marking for Pin 1 (Circle 0,15 mm)	
2	2D-Code, for internal usage only and can be change without any notice	
3	Marking definition see chapter 15.1	

16.1. EXAMPLE FOR MARKING

Ρ	Α	Ν	1	7	2	0			Η	W	/	S	W		
Ε	Ν	W	8	9	8	2	0	Α	Х	Κ	F				
Υ	Υ	W	W	D	L	L									
F	С	С		D	:		Т	7	V	Ρ	Α	Ν	1	7	

16.2. MARKING DEFINITION

- (1) Pin1 marking
- (2) 2D code (Serial number)

(3) Marking:

- PAN172x (Model Name), HW/SW (Hardware/Software version)
- ENW89820AxKF (Part Number, refer to chapter 22)
- Lot code (YearYear, WeekWeek, Day, LotLot)
- ES (Engineering Sample marking)

Note: For available Software Versions, refer to [1] PAN172xETU Design-Guide. and chapter 22 Ordering Information.

17. MECHANICAL REQUIREMENTS

	No.	Item	Limit	Condition
Ī	1	Solderability	More than 75% of the soldering area shall be coated by solder	Reflow soldering with recommendable temperature profile
	2	Resistance to soldering heat	It shall be satisfied electrical requirements and not be mechanical damage	See chapter 13.2

PANASONIC INDUSTRIAL DEVICES EUROPE GMBH

CLASSIFICATION	ICATION PRODUCT SPECIFICATION		No. DS-172x-2400-102		REV. 1.3			
SUBJECT		CLASS 2 BLUETOOTH LOW ENERGY SINGLE MODE MODULE		16 of 2	29			
CUSTOMER'S COD PAN172x / PAN1721	CUSTOMER'S CODE PANASONIC'S CODE			16.08.20	012			
18. DEVELOPMENT OF APPLICATIONS								
For development :	support please	refer to [1] PAN172xETU Design-Guide).					
19. RELIABILITY TESTS								
The measuremen	t should be don	e after being exposed to room tempera	ture and hum	idity for 1 hour.				

No.	Item	Limit	Condition
1	Vibration test	Electrical parameter should be in specification	a) Freq.:10~50Hz,Amplitude:1.5mm a) 20min. / cycle,1hrs. each of XYZ axis b) Freq.:30~100Hz, 6G b) 20min. / cycle,1hrs. each of XYZ axis
2	Shock test	the same as above	Dropped onto hard wood from height of 50cm for 3 times
3	Heat cycle test	the same as above	-40°C for 30min. and +85°C for 30min.; each temperature 300 cycles
4	Moisture test	the same as above	+60°C, 90% RH, 300h
5	Low temp. test	the same as above	-40°C, 300h
6	High temp. test	the same as above	+85°C, 300h

20. CAUTIONS

Failure to follow the guidelines set forth in this document may result in degrading of the product's functions and damage to the product.

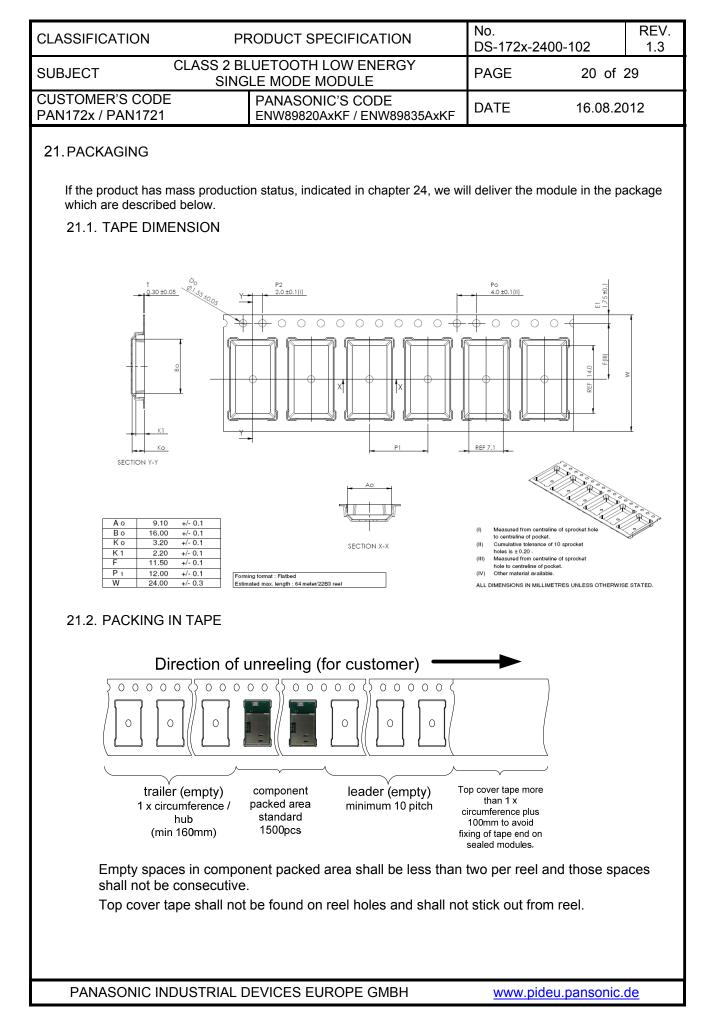
20.1. DESIGN NOTES

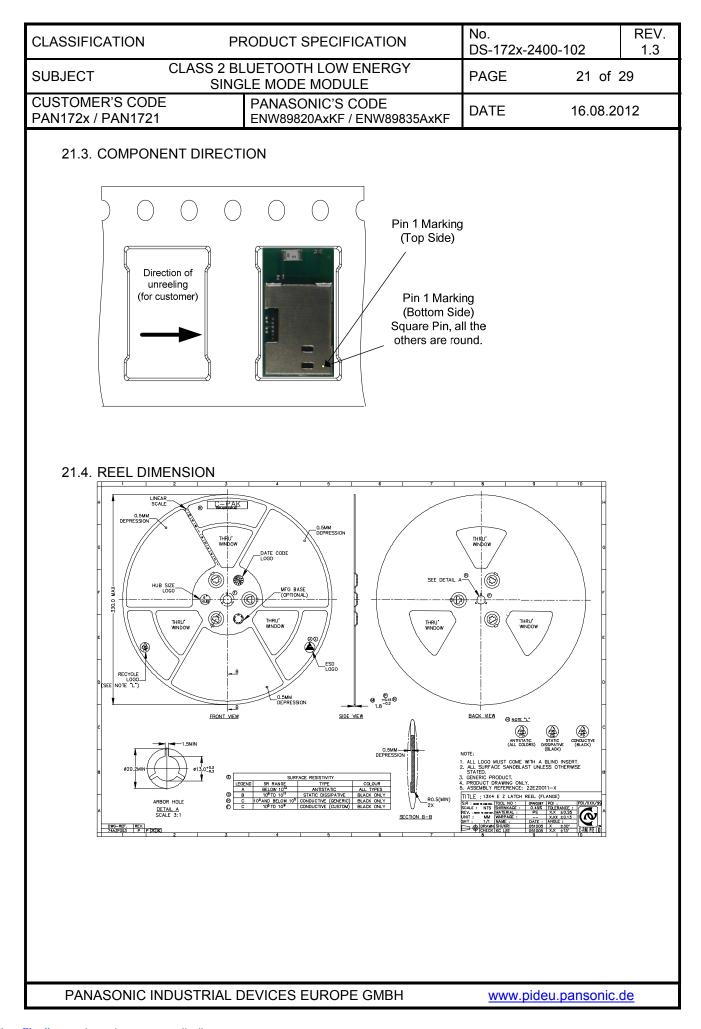
- (1) Follow the conditions written in this specification, especially the control signals of this module.
- (2) The supply voltage has to be free of AC ripple voltage (for example from a battery or a low noise regulator output). For noisy supply voltages, provide a decoupling circuit (for example a ferrite in series connection and a bypass capacitor to ground of at least 47uF directly at the module).
- (3) This product should not be mechanically stressed when installed.
- (4) Keep this product away from heat. Heat is the major cause of decreasing the life of these products.
- (5) Avoid assembly and use of the target equipment in conditions where the products' temperature may exceed the maximum tolerance.
- (6) The supply voltage should not be exceedingly high or reversed. It should not carry noise and/or spikes.
- (7) Keep this product away from other high frequency circuits.

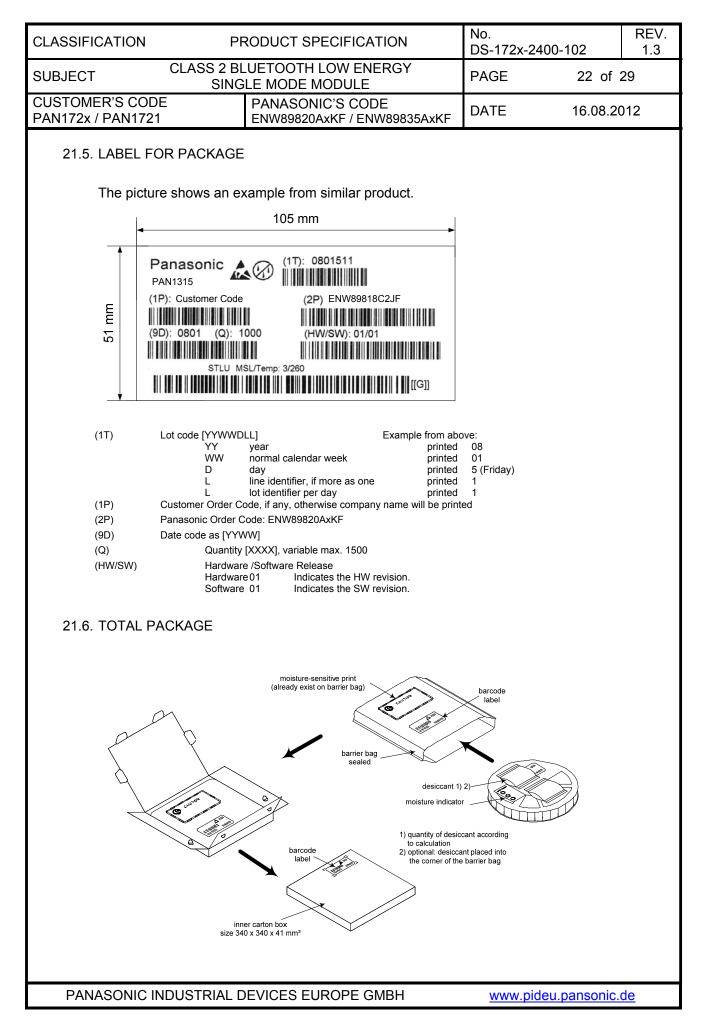
CLASSIFICAT	ION PI	RODUCT SPECIFICATION	No. DS-172x-240	0-102	REV 1.3
SUBJECT		LUETOOTH LOW ENERGY GLE MODE MODULE	PAGE	17 of 2	29
CUSTOMER'S PAN172x / PAI		PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	16.08.20)12
20.2. INS ⁻ (1)	TALLATION NOTES	S s possible twice based on the cor	nditions in chapte	er 15.	
 (2) (3) (4) (5) (6) (7) (8) (8) 	reflow profile. Carefully position boards or affect th Carefully locate th the effects of heat If a vinyl-covered melt and generate the cover and thes This product shou If you want to repa this chapter. Do not wash this p Refer to the recon	ature at the soldering portion of the the products so that their heat will be other components that are susce ese products so that their temper generated by neighboring compo- wire comes into contact with the p toxic gas, damaging the insulation se products to occur. Id not be mechanically stressed of air your board by hand soldering, poroduct.	I not burn into pr ceptible to heat. atures will not in onents. products, then th on. Never allow o r vibrated when please keep the a board.	rinted circuit acrease due e cover will contact betw reflowed. conditions o	to veen of
	damage to the uni	t. on LGA (Land Grid Arrey) solderin			2
(1) (2) (3) (4) (5) (6) (7)	Take measures to If pulses or other to to the products, ch products. Do not use droppe Do not touch, dam Follow the recomme product. Electrode peeling on PCB. Pressing on parts cause damage. These products an	protect the unit against static ele gransient loads (a large load applie neck and evaluate their operation ed products. nage or soil the pins. nended condition ratings about th strength: Do not add pressure of of the metal cover or fastening ob re intended for general purpose an ent, such as home appliances, off	ed in a short time befor assembly e power supply a more than 4.9N bjects to the meta nd standard use	on the final applied to th when solde al cover will in general	nis red
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CLASSIFICATI	ON PF	RODUCT SPECIFICATION	No. DS-172x-2400-102	REV. 1.3							
SUBJECT		UETOOTH LOW ENERGY LE MODE MODULE		of 29							
CUSTOMER'S PAN172x / PAI	CODE	PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE 16.0	8.2012							
20.4. STORAGE NOTES											
(1) The module should not be stressed mechanically during storage.											
(1) (2)	 (2) Do not store these products in the following conditions or the performance characteristics of the product, such as RF performance will be adversely affected: Storage in salty air or in an environment with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NOX 										
	to 35°C range, c • Storage of the p	nvironment where the temperature or where the humidity may be outsi- roducts for more than one year afte heck the adhesive strength of the e	de the 45 to 85% range er the date of delivery \$	e. Storage							
(3) (4) (5)	This product shoul	away from water, poisonous gas an d not be stressed or shocked wher ation when stacking packed crates	n transported.								
20.5. SAF	ETY CAUTIONS										
indiv Befo these circu wher (1)	idual components. re use, check and e e specifications, with it. If electrical shock n a short circuit occu Ensure the safety protection device. Ensure the safety	intended to preserve the quality as valuate the operation when mounte out deviation when using the produ s, smoke, fire, and/or accidents invo- irs, then provide the following fails of the whole system by installing a of the whole system by installing a a single fault causing an unsafe sta	d on your products. Abi lots. These products ma plving human life are ar fe functions, as a minim protection circuit and a redundant circuit or an	de by ay short- nticipated num. a							
20.6. OT⊦	IER CAUTIONS										
(1) (2) (3) (4) (5)	Please do not use Be sure to provide additional damage the product. This product has b the Montreal Proto These products are conditions shown b conditions, check t carefully to determ • In liquid, such a where liquid ma • In direct sunligh • In an environm	e not intended for other uses, other below. Before using these products heir performance and reliability un- ine whether or not they can be use as water, salt water, oil, alkali, or or	an those listed. In your product to preven nal function or the failu one chemical controlled or than under the special of the said special co and in such a manner. Inganic solvent, or in plate the the said special co	ent an re of under Il nditions aces							
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CLASSIFICAT	ION P	RODUCT SPECIFICAT	ION	No. DS-172x-24	400-102	REV. 1.3
SUBJECT		LUETOOTH LOW ENEI GLE MODE MODULE	RGY	PAGE	19 of 2	29
CUSTOMER'S PAN172x / PA		PANASONIC'S CODE ENW89820AxKF / ENW		DATE	16.08.20)12
(6) (7)	If an abnormal vo or circuits, replace able to provide no appearances app	5, NH3, and NOX) Itage is applied due to a e these products with ne ormal performance even ear satisfactory. ny question or uncertain	w products I if their elect	because the ronic charac	y may not be	nts







CLASSIFICATION	PF	RODUCT SPECIFICATION	No. DS-172x-2400	0-102	REV. 1.3
SUBJECT		LUETOOTH LOW ENERGY LE MODE MODULE	PAGE	23 of	29
CUSTOMER'S CODI PAN172x / PAN1721		PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	16.08.20)12

22. ORDERING INFORMATION

Ordering part number	Description	MOQ ⁽¹⁾
ENW89820A1KF ⁽²⁾	PAN1720 CLASS 2 Bluetooth single mode Module according BT-4.0. <i>Bluetooth</i> ® smart device	1500
ENW89820A3KF (2)	PAN1720 Same as above including BlueRadios BR-SPP FW version. Bluetooth® smart device	1500
ENW89835A1KF ⁽²⁾	PAN1721 CLASS 2 Bluetooth single mode Module according BT-4.0. <i>Bluetooth</i> ® smart device	1500
ENW89835A3KF ⁽²⁾	PAN1721 Same as above including BlueRadios BR-SPP FW version. Bluetooth® smart device	1500

Notes:

- (1) Abbreviation for Minimum Order Quantity (MOQ). The standard MOQ for mass production is 1500 pieces, fewer only on customer demand. Samples for evaluation can be delivered at any quantity via the distribution channels.
- (2) Samples are available on customer demand

22.1. INFORMATION REGARDING SOFTWARE VERSIONS

ENW89820A1KF:

The modules will be delivered with an empty flash. Customers need to program their own TI software in the production process. For details refer to the design guide.

ENW89820A3KF:

The modules are delivered with BlueRadios nBlue software. This software includes a bootloader and can be updated over the UART. For the latest revision refer to this link: http://blueradios.com/panasonic/index.php

Note: New customers seeking firmware and firmware support are required to register by providing an invoice number.

CLASSIF	ICATIC	DN	PRODUC	T SPECIFIC	ATION	No. DS-172x-2	400-102	REV. 1.3
SUBJEC ⁻		SIN		oth low ei De module		PAGE	24 of 1	29
CUSTOM PAN172x				SONIC'S CC 9820AxKF / E	DE NW89835AxKF	DATE	16.08.20	012
Here	by we de	REACH DECL	present kr	nowledge base	d on declaration	n of our supplie	rs that this prod	luct
	Pa	nasonic						
		nic Electronic Devices Sloval á 616, 028 01 Trstená	ia s.r.o.					
1		: +421 (0)43 5303 200 21 (0)43 5303 207			MEL C			
	Dear	Customer,			Date: 0	8.12.2011		
	Panas	sonic Electronic Dev	ices Slovaki	a s.r.o., guarantee	e that:			
	Direc	tive 1907/2006 (REA	(CH)					
	(SVH	tances from the can (C) published by EC roducts above 0.1% (IA are regu					
	suppli	o the high complexi iers, this process re nation regarding our	quired some	time. We will	provide you with	n all substance		
	Pana: manu	<i>sonic Electronic Dev</i> factured and delivere	<i>ices Slovaki</i> d to your co	<i>a s.r.o.</i> hereby de mpany have SVH	clares that all prod [C substances < 0.1	lucts 1% (w/w).		
	Direc	tive 2002/95/EC (Re	HS)					
	follow	confirm that all proc ving substances whic num concentration of	h are banne	d by Directive 20	002/95/EC (RoHS)) or if contain a		
	Mercu	and lead compounds, ary and mercury compo nium (VI),	ınds,					
	PBB () PBDE and a r	polybrominated bipheny (polybrominated biphen naximum concentration of ium and cadmium comp	nyl ether) cate f 0.01% by we	e gory ight in homogeneou	s materials for:			
	Wire	less Modules (ENW	398series; E	NW596series; EN	WC9Aseries)			
	Create:	Kostalikova Alena	Check:	Firmentova Viera	Approval:	Kashiwaya Shinichi		
	EQ	John L	QA&QC	PA	Managing Director	S. Keshiwaya		
				/				
For th	he most	updated one, plea	ase refer to	o [4].				
PAN	NASON	IC INDUSTRIAL	DEVICE	S EUROPE	GMBH	www.pic	deu.pansonic.	<u>de</u>

CLASSIFICATION	PF	RODUCT SPECIFICATION	No. DS-172x-2400)-102	REV. 1.3
SUBJECT		UETOOTH LOW ENERGY LE MODE MODULE	PAGE	25 of 2	29
CUSTOMER'S CODE PAN172x / PAN1721		PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	16.08.20)12

24. DATA SHEET STATUS

This data sheet contains the final specification (RELEASE).

Panasonic reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

Please consult the most recently issued data sheet before initiating or completing a design.

Use this URL to search for the most recent version of this data sheet: Use this URL to search for the most recent version of this data sheet:

PAN172x Datasheet

25. HISTORY FOR THIS DOCUMENT

Revision	Date	Modification / Remarks
0.01	November 2011	1 st preliminary version.
0.02	November 2011	Deleted footnote in chapter 11.
1.00	April 2012	Released Version.
1.1	July 2012	Add chapter 22.1 Information regarding Software Versions. Link to LGA app note. Removed watermark. UART pinning for BR-SW version. I2C pinning for PAN1721 version. FCC, IC, IDs.
1.2	July 2012	Added remark "top view" for footprint. Corrected FCC ID to T7VPAN17. Change to the correct company name in footer.
1.3	Agust 2012	Change IC text in chapter 29.1 Change to the correct company name in footer. New format for chapter Related Documents

26. RELATED DOCUMENTS

For an update, please search in the suitable homepage.

- [1] PAN172xETU Design-Guide http://www.pideu.panasonic.de/pdf/168ApplicationNote.pdf
- [2] Semiconductor Datasheet <u>CC2540 from Texas Instruments</u> <u>CC2541 from Texas Instruments</u>
- [3] Application Note Land Grid Array http://www.pideu.panasonic.de/pdf/184ext.pdf
- [4] REACH and RoHS Certificate http://www.pideu.panasonic.de/pdf/182ext2.jpg

PANASONIC INDUSTRIAL DEVICES EUROPE GMBH

CLASSIFICATION F	No. DS-172x-2400-102		REV. 1.3			
ISUBJECT	BLUETOOTH LOW ENERGY GLE MODE MODULE	PAGE	26 of	29		
CUSTOMER'S CODE PAN172x / PAN1721	PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	16.08.20	012		
 27. GENERAL INFORMATION © Panasonic Industrial Devices Europe GmbH 2012. All rights reserved. This product description does not lodge the claim to be complete and free of mistakes. Please contact the related product manager in every case. If we deliver ES samples to the customer, these samples have the status Engineering Samples. This means, the design of this product is not yet concluded. Engineering Samples may be partially or fully functional, and there may be differences to be published Data Sheet. Engineering Samples are not qualified and are not to be used for reliability testing or series production. 						

Disclaimer:

Customer acknowledges that samples may deviate from the Data Sheet and may bear defects due to their status of development and the lack of qualification mentioned above.

Panasonic rejects any liability or product warranty for Engineering Samples. In particular, Panasonic disclaims liability for damages caused by

- the use of the Engineering Sample other than for Evaluation Purposes, particularly the installation or integration in an other product to be sold by Customer,
- deviation or lapse in function of Engineering Sample,
- improper use of Engineering Samples.

Panasonic disclaimes any liability for consequential and incidental damages.

In case of any questions, please contact your local sales partner or the related product manager.

28. REGULATORY INFORMATION

28.1. FCC NOTICE

The devices PAN17, for details refer to Chapter 22, including the antennas, which are listed in 28.5, complies with Part 15 of the FCC Rules. The device meets the requirements for modular transmitter approval as detailed in FCC public Notice DA00-1407.transmitter Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) This device must accept any interference received, including interference that may cause undesired operation.

28.2. CAUTION



The FCC requires the user to be notified that any changes or modifications made to this device that are not expressly approved by Panasonic Industrial Devices Europe GmbH may void the user's authority to operate the equipment.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

CLASSIFICATION	PF	RODUCT SPECIFICATION	No. DS-172x-2400)-102	REV. 1.3
SUBJECT	01,000101	LUETOOTH LOW ENERGY LE MODE MODULE	PAGE	27 of 2	29
CUSTOMER'S CODI PAN172x / PAN1721		PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	16.08.20)12

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help

28.3. LABELING REQUIREMENTS



The Original Equipment Manufacturer (OEM) must ensure that FCC labeling requirements are met. This includes a clearly visible label on the outside of the OEM enclosure specifying the appropriate Panasonic FCC identifier for this product as well as the FCC Notice above. The FCC identifier are **FCC ID: T7VPAN17**. This FCC identifier is valid for all PAN172x modules, for details, see the Chapter 22. Ordering Information.

In any case the end product must be labelled exterior with "Contains FCC ID: T7VPAN17"

28.4. ANTENNA WARNING

For the related part number of PAN172x refer to Chapter 22. Ordering Information.

This devices are tested with a standard SMA connector and with the antennas listed below. When integrated in the OEMs product, these fixed antennas require installation preventing end-users from replacing them with non-approved antennas. Any antenna not in the following table must be tested to comply with FCC Section 15.203 for unique antenna connectors and Section 15.247 for emissions. The FCC identifier for this device with the antenna listed in item 1 are the same (FCC ID: T7VPAN17).

28.5. APPROVED ANTENNA LIST

Note: We are able to qualify your antenna and will add to this list as that process is completed.

Item	Part Number	Manufacturer	Frequency Band	Туре	Gain (dBi)
2	LDA212G3110K	Murata	2.4GHz	Chip-Antenna	+0.9

28.6. RF EXPOSURE PAN172X

To comply with FCC RF Exposure requirements, the Original Equipment Manufacturer (OEM) must ensure that the approved antenna in the previous table must be installed.

The preceding statement must be included as a CAUTION statement in manuals for products operating with the approved antennas in the previous table to alert users on FCC RF Exposure compliance.

Any notification to the end user of installation or removal instructions about the integrated radio module is not allowed.

The radiated output power of PAN172x with mounted ceramic antenna **(FCC ID: T7VPAN17)** is far below the FCC radio frequency exposure limits. Nevertheless, the PAN172x shall be used in such a manner that the potential for human contact during normal operation is minimized.

End users may not be provided with the module installation instructions. OEM integrators and end users must be provided with transmitter operating conditions for satisfying RF exposure compliance.

CLASSIFICATION	PRODUCT SPECIFICATIC	N No. DS-172x-24	00-102	REV. 1.3
	2 BLUETOOTH LOW ENERG	GY PAGE	28 of	29
CUSTOMER'S CODE PAN172x / PAN1721	PANASONIC'S CODE ENW89820AxKF / ENW89	9835AxKF DATE	16.08.2	012
29. INDUSTRY CANADA CE	RTIFICATION			
license: IC: 216Q-P Manufacturers of m clarify any regulator	t to meet the regulatory requin AN17 obile, fixed or portable devic y questions and ensure com unadian information on RF exp	es incorporating this mo pliance for SAR and/or	odule are ad RF exposur	e limits.
a maximum gain of dBi are strictly prof ohms. The antenn conjunction with any Due to the model si	n designed to operate with th 0.9 dBi. Antennas not include hibited for use with this devic a used for this transmitter other antenna or transmitter. ze the IC identifier is displayed the modules label due to the	d in this list or having a ce. The required anten must not be co-loca ed in the installation inst	gain greater f na impedanc ted or opera ruction only a	than 0.9 ce is 50 ating ir
in 28.5, complies v modular trans Operation is subject	t to the following two condition (2) This device must acc	s. The device meets t as detailed ons: (1) This device ma	he requirem in RS y not cause received, ir	ents fo S-GEN harmfu
met. This includes a appropriate Panaso	nent Manufacturer (OEM) mu a clearly visible label on the c nic IC identifier for this produ AN17. This IC identifier is val	outside of the OEM enc uct as well as the IC N	losure specif otice above.	ying the The IC
In any case "Contains IC: 216Q-	the end product PAN17"	must be labelled	d exterior	with
30. EUROPEAN R&TTE DEC	CLARATION OF CONFORMI	ГҮ		
PAN172x and their versi provisions of Directive	ustrial Devices Europe Gm ons is in compliance with the 1999/5/EC. As a result c of the Directive 1999/5/EC,	e essential requirements of the conformity asso	s and other r	elevant cedure
countries: Austria, Belg Germany, Greece, Hun	sions in the specified refere ium, Cyprus, Czech Repul gary, Ireland, Italy, Latvia, ovenia, Spain, Sweden, T	olic, Denmark, Estonia Lithuania, Luxembou	a, Finland, I irg, Malta, I	⁻ rance, Poland,

CLASSIFICATION	PF	RODUCT SPECIFICATION	No. DS-172x-240	0-102	REV. 1.3
SUBJECT		UETOOTH LOW ENERGY LE MODE MODULE	PAGE	29 of 2	29
CUSTOMER'S CODE PAN172x / PAN1721		PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF	DATE	16.08.20)12

31.LIFE SUPPORT POLICY

This Panasonic product is not designed for use in life support appliances, devices, or systems where malfunction can reasonably be expected to result in a significant personal injury to the user, or as a critical component in any life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness. Panasonic customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Panasonic for any damages resulting.